



Surface Mount Schottky Barrier Rectifier
Reverse Voltage - 40V
Forward Current - 3.0A

FEATURES

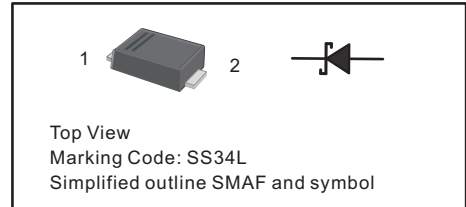
- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

MECHANICAL DATA

- Case: SMAF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 27mg / 0.00095oz

PINNING

| PIN | DESCRIPTION |
|-----|-------------|
| 1 | Cathode |
| 2 | Anode |



Absolute Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz resistive or inductive load, for capacitive load, derate by 20 %

| Parameter | Symbols | SS34LF | Units |
|--|-----------------|------------|---------------|
| Maximum Repetitive Peak Reverse Voltage | V_{RRM} | 40 | V |
| Maximum RMS voltage | V_{RMS} | 28 | V |
| Maximum DC Blocking Voltage | V_{DC} | 40 | V |
| Maximum Average Forward Rectified Current | $I_{F(AV)}$ | 3.0 | A |
| Peak Forward Surge Current, 8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method) | I_{FSM} | 80 | A |
| Max Instantaneous Forward Voltage at 3 A | V_F | 0.5 | V |
| Maximum DC Reverse Current $T_a = 25^{\circ}C$ at Rated DC Reverse Voltage $T_a = 100^{\circ}C$ | I_R | 0.3 5 | mA |
| Typical Junction Capacitance ⁽¹⁾ | C_j | 300 | pF |
| Typical Thermal Resistance ⁽²⁾ | $R_{\theta JA}$ | 65 | $^{\circ}C/W$ |
| Operating Junction Temperature Range | T_j | -55 ~ +150 | $^{\circ}C$ |
| Storage Temperature Range | T_{stg} | -55 ~ +150 | $^{\circ}C$ |

(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.



Fig.1 Forward Current Derating Curve

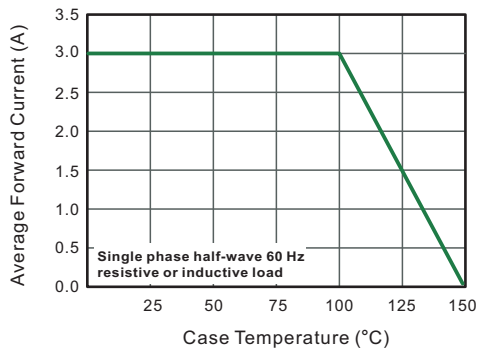


Fig.2 Typical Reverse Characteristics

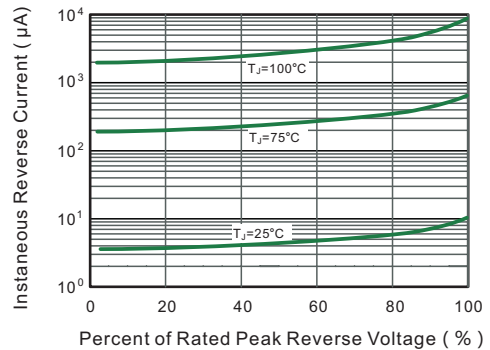


Fig.3 Typical Forward Characteristic

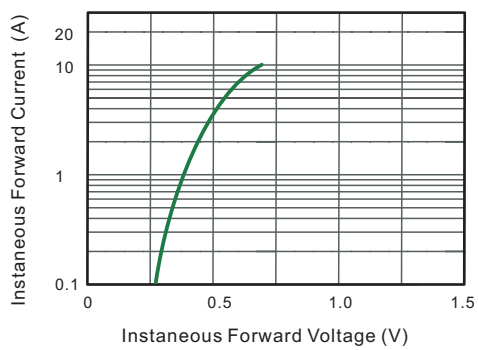


Fig.4 Typical Junction Capacitance

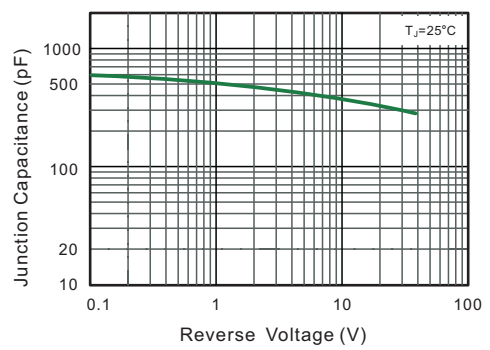


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

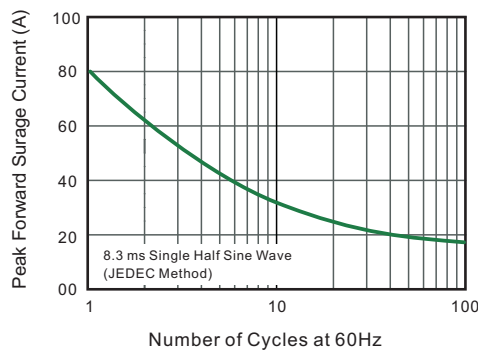
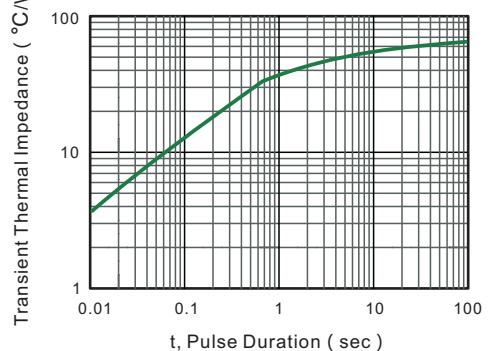


Fig.6- Typical Transient Thermal Impedance

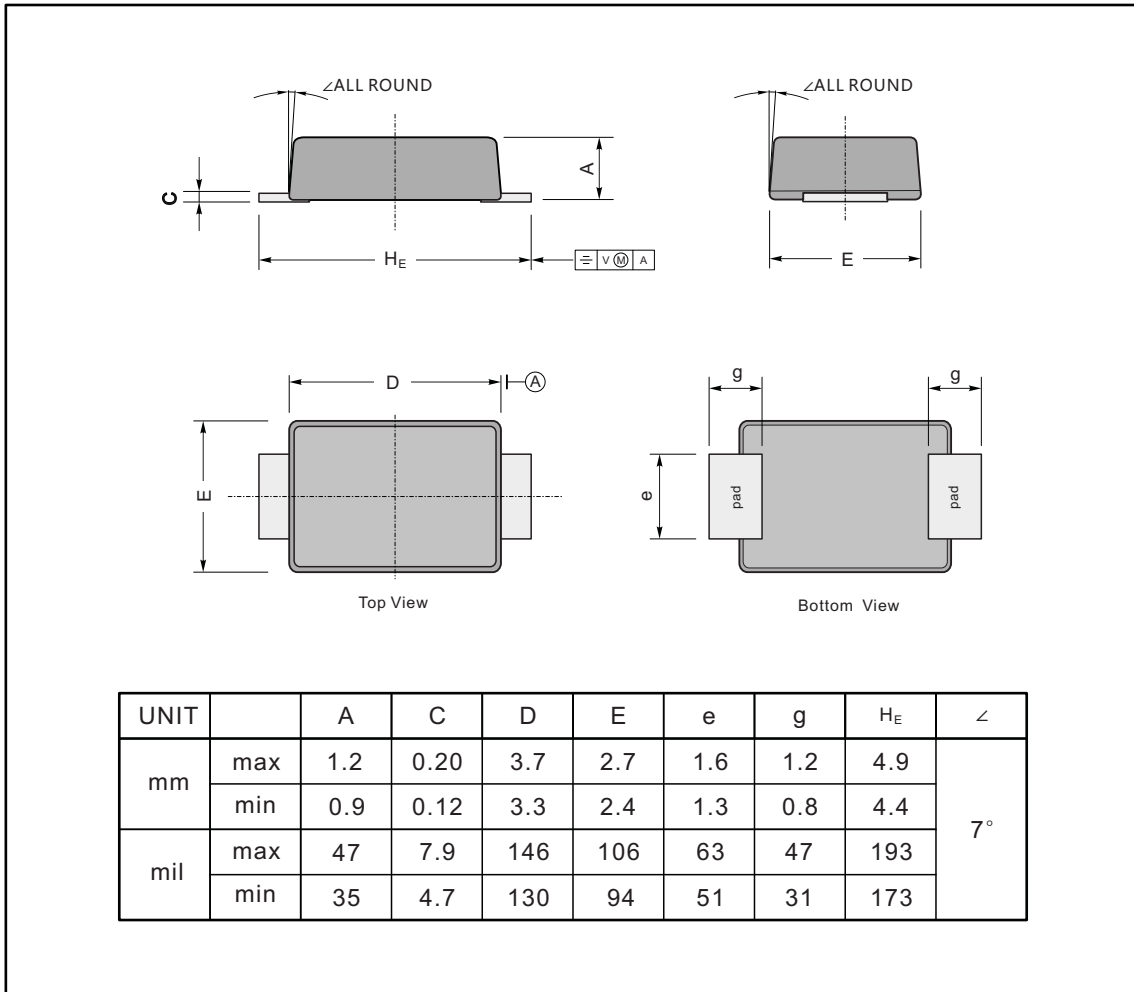




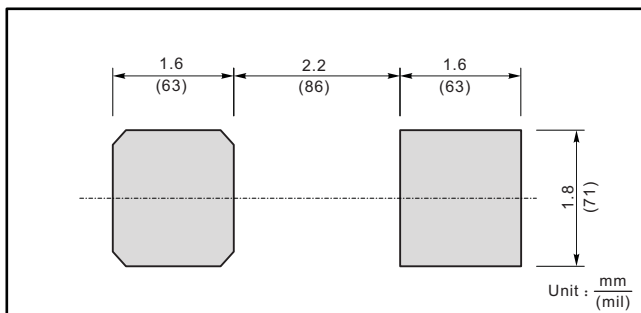
PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMAF



The recommended mounting pad size



Marking

| Type number | Marking code |
|-------------|--------------|
| SS34LF | SS34L |